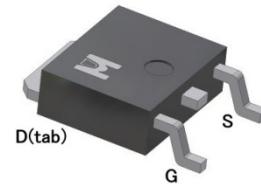
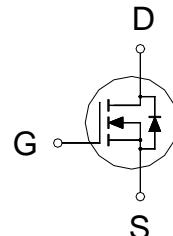


N-Channel Logic Level Enhancement Mode Field Effect Transistor

Product Summary:

|                     |               |
|---------------------|---------------|
| $BV_{DSS}$          | 100V          |
| $R_{DS(on)}$ (MAX.) | 100m $\Omega$ |
| $I_D$               | 16A           |



UIS,  $R_g$  100% Tested

Pb-Free Lead Plating & Halogen Free



ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ C$  Unless Otherwise Noted)

| PARAMETERS/TEST CONDITIONS                     |                                    | SYMBOL         | LIMITS     | UNIT |
|--|------------------------------------|----------------|------------|------|
| Gate-Source Voltage                            |                                    | $V_{GS}$       | $\pm 20$   | V    |
| Continuous Drain Current                       | $T_C = 25^\circ C$                 | $I_D$          | 16         | A    |
|  | $T_C = 100^\circ C$                |                | 10         |      |
| Pulsed Drain Current <sup>1</sup>              |                                    | $I_{DM}$       | 45         |      |
| Avalanche Current                              |                                    | $I_{AS}$       | 12         |      |
| Avalanche Energy                               | $L = 0.1mH, I_D=12A, R_G=25\Omega$ | $E_{AS}$       | 7.2        | mJ   |
| Repetitive Avalanche Energy <sup>2</sup>       | $L = 0.05mH$                       | $E_{AR}$       | 3.6        |      |
| Power Dissipation                              | $T_C = 25^\circ C$                 | $P_D$          | 40         | W    |
|  | $T_C = 100^\circ C$                |                | 16         |      |
| Operating Junction & Storage Temperature Range |                                    | $T_j, T_{stg}$ | -55 to 150 | °C   |

THERMAL RESISTANCE RATINGS

| THERMAL RESISTANCE  | SYMBOL          | TYPICAL | MAXIMUM | UNIT   |
|---------------------|-----------------|---------|---------|--------|
| Junction-to-Case    | $R_{\theta JC}$ | 3.1     | 3.1     | °C / W |
| Junction-to-Ambient | $R_{\theta JA}$ |         | 62.5    |        |

<sup>1</sup>Pulse width limited by maximum junction temperature.

<sup>2</sup>Duty cycle ≤ 1%

ELECTRICAL CHARACTERISTICS ( $T_J = 25^\circ\text{C}$ , Unless Otherwise Noted)

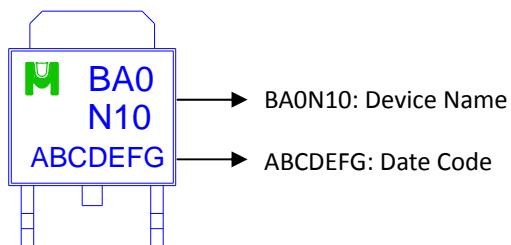
| PARAMETER   | SYMBOL                      | TEST CONDITIONS  | LIMITS |     |           | UNIT             |
|---|-----------------------------|--|--------|-----|-----------|------------------|
|   |                             |  | MIN    | TYP | MAX       |                  |
| STATIC  |                             |  |        |     |           |                  |
| Drain-Source Breakdown Voltage  | $V_{(\text{BR})\text{DSS}}$ | $V_{GS} = 0V, I_D = 250\mu\text{A}$                      | 100    |     |           | V                |
| Gate Threshold Voltage  | $V_{GS(\text{th})}$         | $V_{DS} = V_{GS}, I_D = 250\mu\text{A}$                  | 1.0    | 1.8 | 3.0       |                  |
| Gate-Body Leakage   | $I_{GSS}$                   | $V_{DS} = 0V, V_{GS} = \pm 20V$                          |        |     | $\pm 100$ | nA               |
| Zero Gate Voltage Drain Current   | $I_{DSS}$                   | $V_{DS} = 80V, V_{GS} = 0V$                              |        |     | 1         | $\mu\text{A}$    |
|   |                             | $V_{DS} = 70V, V_{GS} = 0V, T_J = 125^\circ\text{C}$     |        |     | 25        |                  |
| On-State Drain Current <sup>1</sup>   | $I_{D(\text{ON})}$          | $V_{DS} = 10V, V_{GS} = 10V$                             | 16     |     |           | A                |
| Drain-Source On-State Resistance <sup>1</sup>                               | $R_{DS(\text{ON})}$         | $V_{GS} = 10V, I_D = 12A$                                |        | 90  | 100       | $\text{m}\Omega$ |
|   |                             | $V_{GS} = 4.5V, I_D = 8A$                                |        | 100 | 125       |                  |
| Forward Transconductance <sup>1</sup>                                       | $g_{fs}$                    | $V_{DS} = 5V, I_D = 12A$                                 |        | 9   |           | S                |
| DYNAMIC   |                             |  |        |     |           |                  |
| Input Capacitance   | $C_{iss}$                   | $V_{GS} = 0V, V_{DS} = 25V, f = 1\text{MHz}$             |        | 715 |           | $\text{pF}$      |
| Output Capacitance  | $C_{oss}$                   |  |        | 54  |           |                  |
| Reverse Transfer Capacitance  | $C_{rss}$                   |  |        | 24  |           |                  |
| Gate Resistance   | $R_g$                       | $V_{GS} = 15\text{mV}, V_{DS} = 0V, f = 1\text{MHz}$     |        | 3.6 |           | $\Omega$         |
| Total Gate Charge <sup>1,2</sup>  | $Q_g$                       | $V_{DS} = 80V, V_{GS} = 10V, I_D = 12A$                  |        | 13  |           | $\text{nC}$      |
| Gate-Source Charge <sup>1,2</sup>   | $Q_{gs}$                    |  |        | 3   |           |                  |
| Gate-Drain Charge <sup>1,2</sup>  | $Q_{gd}$                    |  |        | 4.6 |           |                  |
| Turn-On Delay Time <sup>1,2</sup>   | $t_{d(\text{on})}$          | $V_{DS} = 50V, I_D = 1A, V_{GS} = 10V, R_{GS} = 6\Omega$ |        | 10  |           | $\text{nS}$      |
| Rise Time <sup>1,2</sup>  | $t_r$                       |  |        | 12  |           |                  |
| Turn-Off Delay Time <sup>1,2</sup>  | $t_{d(\text{off})}$         |  |        | 20  |           |                  |
| Fall Time <sup>1,2</sup>  | $t_f$                       |  |        | 15  |           |                  |
| SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ( $T_c = 25^\circ\text{C}$ ) |                             |  |        |     |           |                  |
| Continuous Current  | $I_s$                       |  |        |     | 16        | $\text{A}$       |
| Pulsed Current <sup>3</sup>   | $I_{SM}$                    |  |        |     | 45        |                  |
| Forward Voltage <sup>1</sup>  | $V_{SD}$                    | $I_F = I_s, V_{GS} = 0V$                                 |        |     | 1.3       | V                |
| Reverse Recovery Time   | $t_{rr}$                    | $I_F = 10A, dI_F/dt = 100A/\mu\text{s}$                  |        | 50  |           | $\text{nS}$      |
| Reverse Recovery Charge   | $Q_{rr}$                    |  |        | 85  |           |                  |

<sup>1</sup>Pulse test : Pulse Width  $\leq 300\ \mu\text{sec}$ , Duty Cycle  $\leq 2\%$ .<sup>2</sup>Independent of operating temperature.

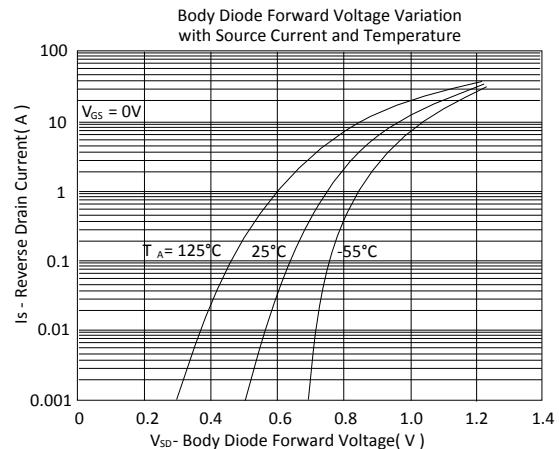
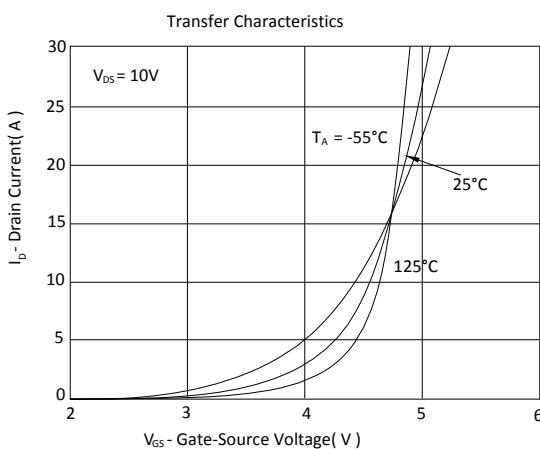
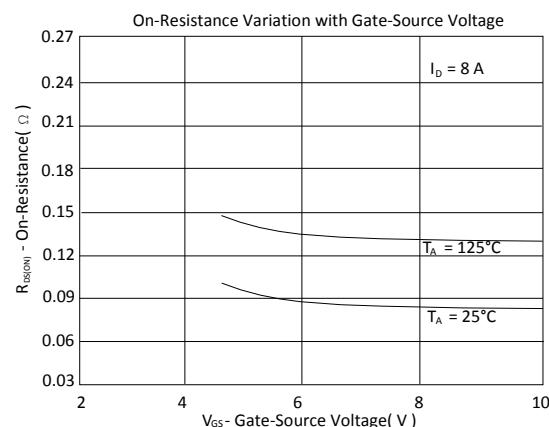
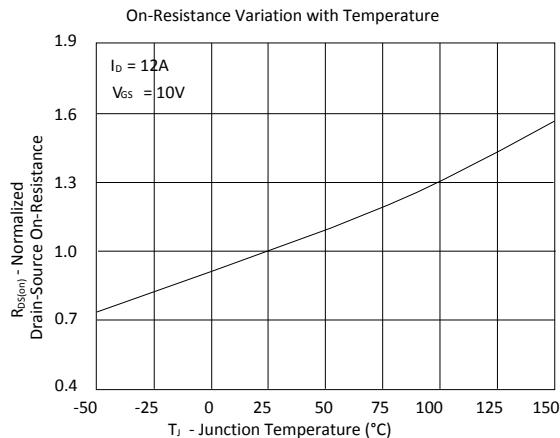
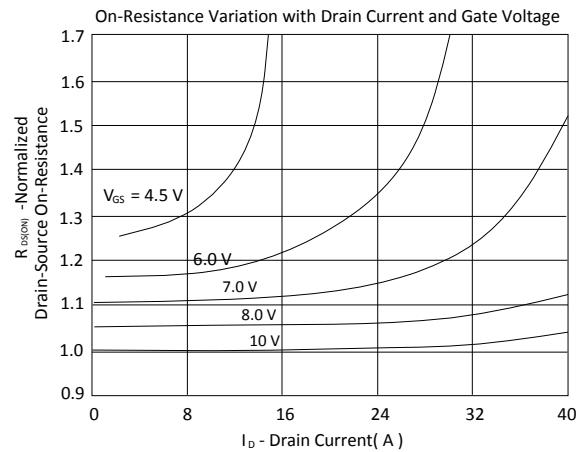
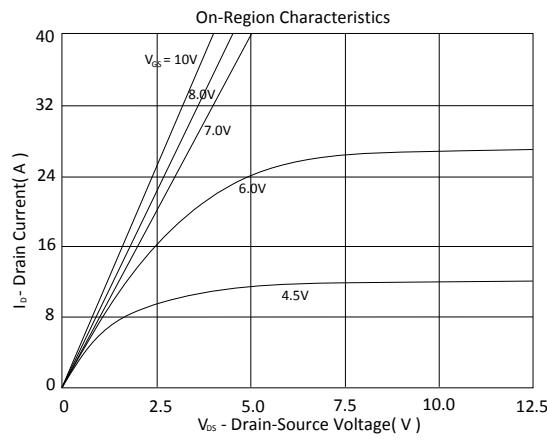
<sup>3</sup>Pulse width limited by maximum junction temperature.

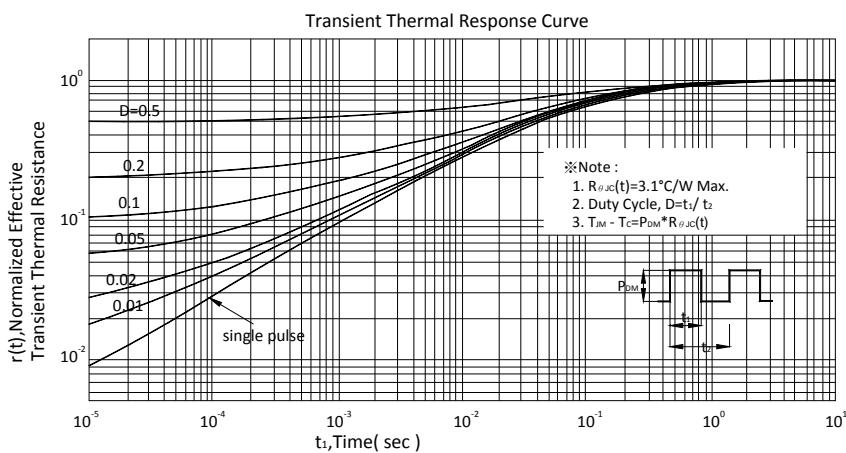
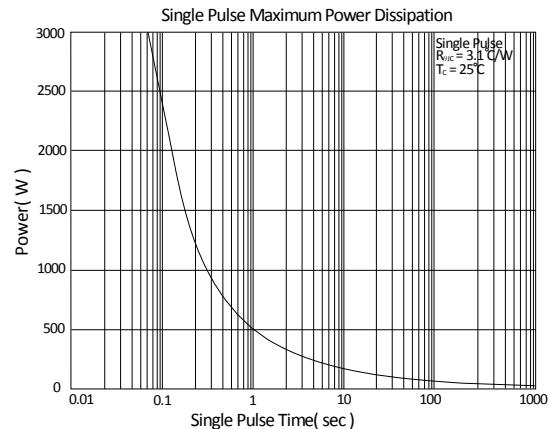
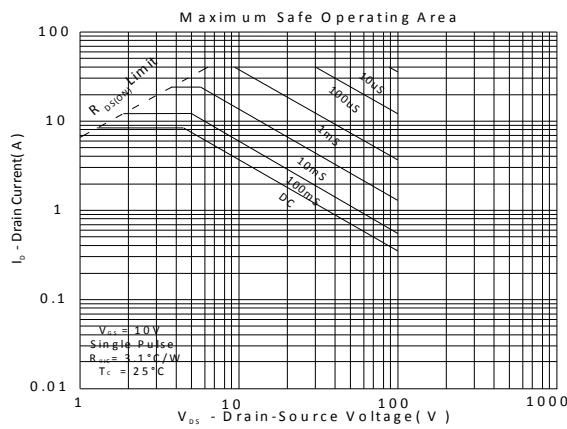
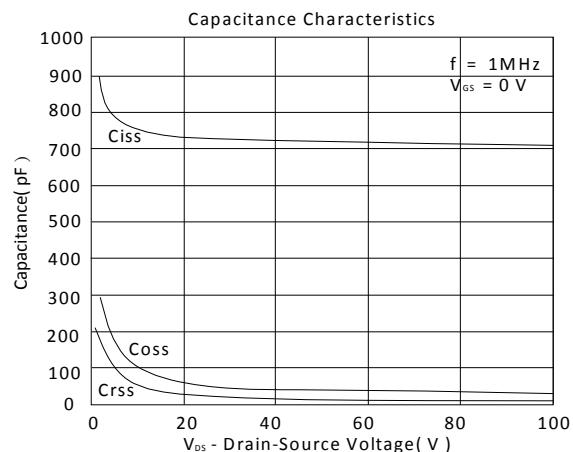
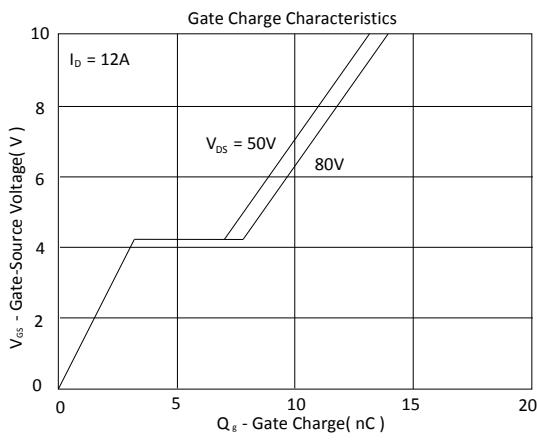
Ordering & Marking Information:

Device Name: EMBA0N10A for DPAK (TO-252)

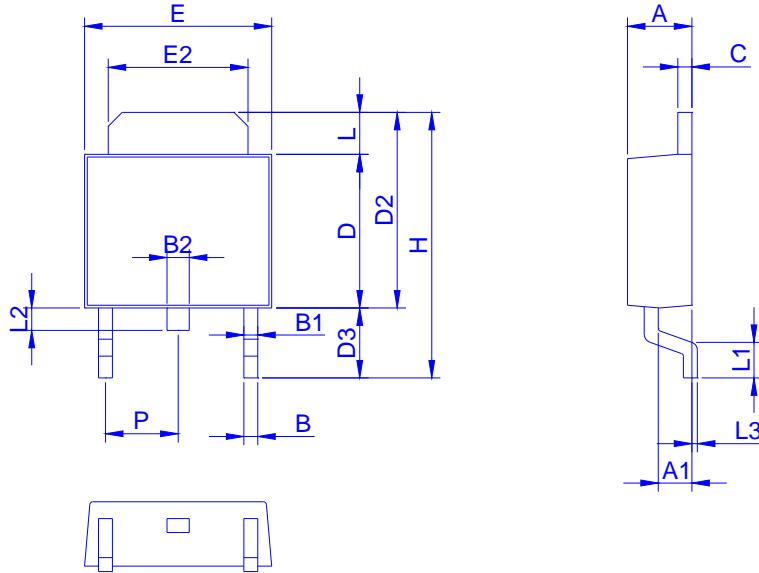


TYPICAL CHARACTERISTICS





Outline Drawing



| Dimension | A    | A1   | B    | B1   | B2   | C    | D    | D2   | D3   | E    | E2   | H     | L    | L1   | L2   | L3   | P    |
|-----------|------|------|------|------|------|------|------|------|------|------|------|-------|------|------|------|------|------|
| Min.      | 2.10 | 0.95 | 0.30 | 0.40 | 0.60 | 0.40 | 5.30 | 6.70 | 2.20 | 6.40 | 4.80 | 9.20  | 0.89 | 0.90 | 0.50 | 0.00 | 2.10 |
| Max.      | 2.50 | 1.30 | 0.85 | 0.94 | 1.00 | 0.60 | 6.20 | 7.30 | 3.00 | 6.70 | 5.45 | 10.15 | 1.70 | 1.65 | 1.10 | 0.30 | 2.50 |

Footprint

